

- NOTES
1. ALL EXPOSED METAL AND METALLIZED AREA SHALL BE GOLD PLATED 60 MICRO INCHES MIN. THICKNESS OVER 50 MICRO INCHES MIN. THICKNESS OF NICKEL UNLESS OTHERWISE SPECIFIED BY PURCHASE ORDER.
 2. LEAD RESISTANCE : 0.5 OHM MAX.
 3. SEAL RING AND DIE ATTACH PAD AREA NOT GROUND TO A LEAD. (ZERO GROUND)

OPTION		
PART NO	DIE ATTACH METALLIZATION	
01	WITH	AFO-40F
02	WITHOUT	SFO-40F

4-.020 DIA. VENDOR'S OPTION

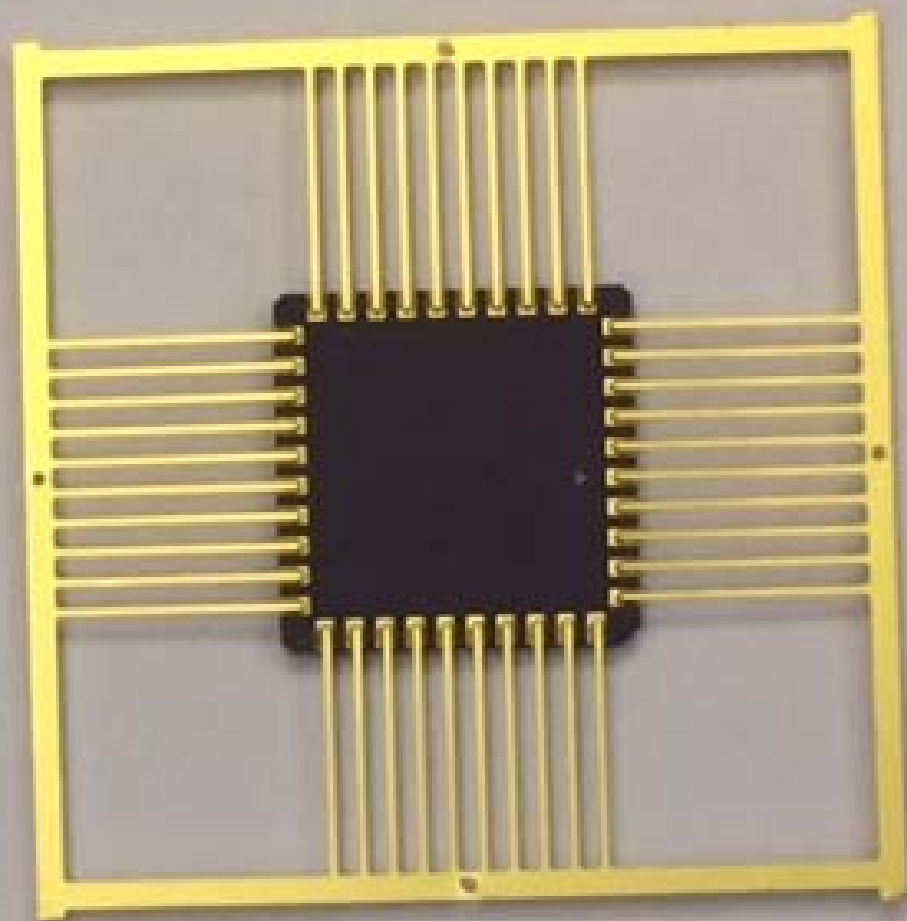
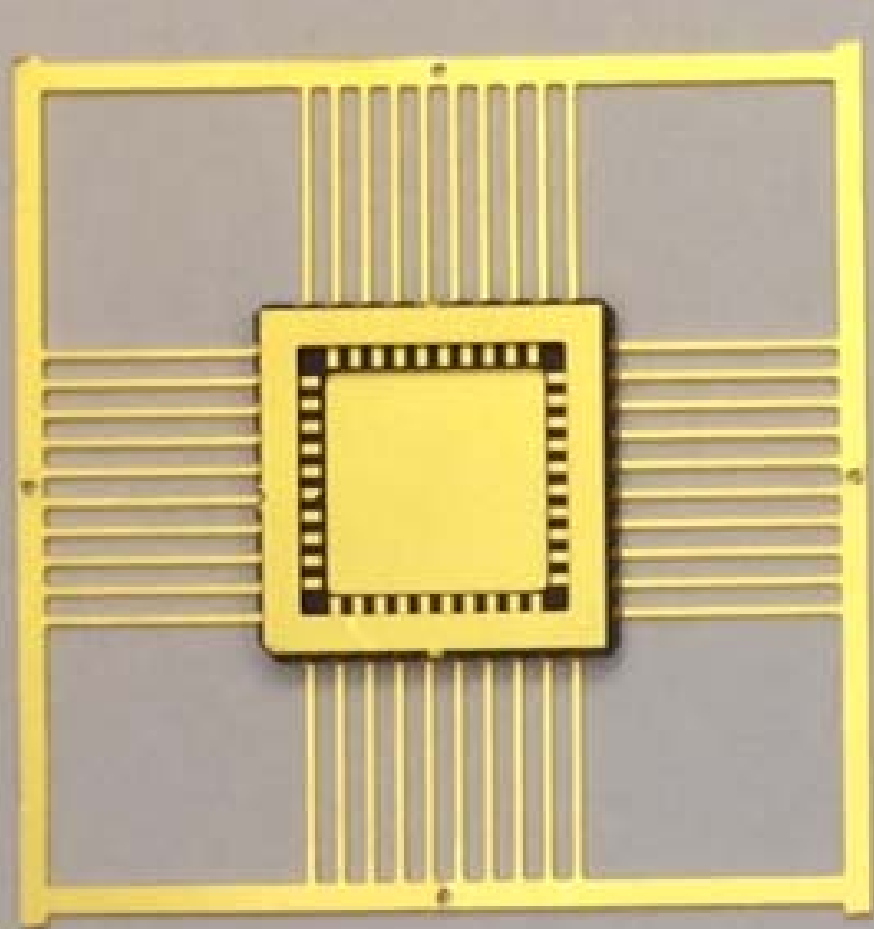
CONTROLLED 9/4/01

PB-02479 (MR-40F) MOD.

MODIFICATIONS	DATE	DRAWN	CHECKED	APPROVED
ADD:TABLE, 4-.020 DIA. CHANGE	03.01.86	T.J	T.Y	Y.S

NAME 40 LEAD FLAT PACK	TOLERANCES UNLESS OTHERWISE SPECIFIED ± 1% N.L.T ±.005 90° ANGLE PROJECTION	DRAWN T.J	CHECKED T.Y	APPROVED Y.S	DATE 11.1.85
SCALE 10/1	MATERIAL AS INDICATED	DRAWING NO. PB-F85520-A		SHEET	
KYOCERA CORPORATION KYOTO JAPAN					





0 inch

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